

OMNIMATE Data - RJ45 jacks transformer RJ45G1 R1V 3.3N4YG/YG TY

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RJ45 transmitter sockets (magnetics) for gigabit applications (1000 base-T) with integrated compensation actively counteracts inductive and capacitive couplings and saves space on the PCB.

The product range encompasses the following designs:

- 90°, lying (horizontal) and 180°, standing (vertical)
- latch up / latch down
- THT, THR or SMD soldering processes
- Wide range of different design types, also with integrated LEDs and shield contact tabs
- Transmission rates of up to 1 Gbps
- Packed either in a tray (TY) or on a roll (tape-on-reel, RL)
- Compatible with modular RJ45 connector according to ANSI / TIA-1096-A and IEC 60603
- Dielectric strength ≥ 1500 V AC RMS (2250 V AC peak value) according to IEEE 802.3
- Dielectric strength ≥ 1500 V AC (peak value) or ≥ 1500 V DC according to IEC 60603
- Compliance with IEEE 802.3 requirements (1000Base-T, 1 Gbps, IEEE 802.3ab or 100Base-Tx, 100 Mbps, IEEE 802.3u)

Properties and advantages:

- Extended temperature range of -40 °C to $+85$ °C for maximum performance
- Reinforced gold layer (30µ") for improved corrosion protection

- At least 3 mm stand-off ensures a perfect soldering result

General ordering data

Type	RJ45G1 R1V 3.3N4YG/YG TY
Order No.	1534760000
Version	PCB plug-in connector, RJ45 jacks transformer, 1000 Mbps, THT/THR solder connection, 180°, Shield tabs: none, 30-80 µ" Ni / 30- µ" Au, LED: Yes, Green/yellow, Green/yellow, No. of poles: 10, Tray (manual assembly)
GTIN (EAN)	4050118338423
Qty.	120 pc(s).
Packaging	Tray (manual assembly)

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Technical data

Dimensions and weights

Width	16 mm	Width (inches)	0.63 inch
Height	20.3 mm	Height (inches)	0.799 inch
Height of lowest version	17 mm	Depth	16.8 mm
Depth (inches)	0.661 inch	Net weight	3.783 g

Temperatures

Operating temperature, max.	85 °C	Operating temperature, min.	-40 °C
Storage temperature, max.	85 °C	Storage temperature, min.	-40 °C

Environmental Product Compliance

REACH SVHC	Lead 7439-92-1
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System specifications

Colour of left LED	Green/yellow	Colour of right LED	Green/yellow
LED	Yes	Mounting onto the PCB	THT/THR solder connection
No. of poles	10	Number of solder pins per pole	1
Outgoing elbow	180°	Pitch in inches (P)	0.05 inch
Pitch in mm (P)	1.27 mm	Plugging cycles	750
Product family	OMNIMATE Data - RJ45 jacks transformer	Protection degree	IP20
Shield surface	nickel-plated	Shield tabs	none
Shielding	Yes	Shielding material	Brass
Solder eyelet hole diameter (D)	0.9 mm	Solder eyelet hole diameter tolerance (D)±	0.1 mm
Solder pin dimensions	0.40 x 0.30 mm, LED pins = 0.50 x 0.50 mm	Solder pin length (l)	3.2 mm
Transmission rate	1000 Mbps	Type of connection	Socket connector
Wiring	10-wire		

Electrical properties

Dielectric strength, contact / contact	1000 V DC	Dielectric strength, contact / shield	1500 V DC
Insulation strength	> 500 MΩ	Rated current	1.5 A
Rated voltage	125 V AC		

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	II
CTI	≥ 500	Insulation strength	> 500 MΩ
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact base material	Phosphorus bronze	Contact surface	Gold over nickel
Layer structure of plug contact	30-80 μ" Ni / 30- μ" Au	Storage temperature, min.	-40 °C
Storage temperature, max.	85 °C	Operating temperature, min.	-40 °C
Operating temperature, max.	85 °C		

Packing

Packaging	Tray (manual assembly)	VPE length	25 mm
VPE width	175 mm	VPE height	300 mm

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Technical data**Classifications**

ETIM 6.0	EC002637	eClass 6.2	27-25-05-04
eClass 7.1	27-25-05-04	eClass 8.1	19-17-01-25
eClass 9.0	27-44-04-02	eClass 9.1	27-44-04-02

Approvals

Approvals



ROHS	Conform
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Downloads

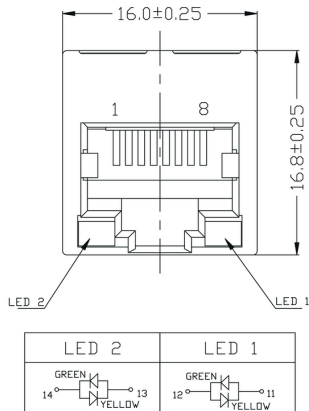
Brochure/Catalogue	MB FREECONTACT EN FL FIELDWIRING EN PI PROFINET CABLING EN
Engineering Data	STEP
User Documentation	MAN IE GUIDE DE MAN IE GUIDE EN

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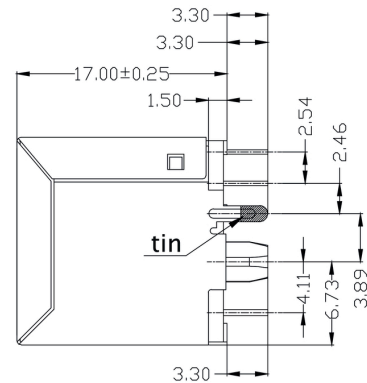
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Drawings

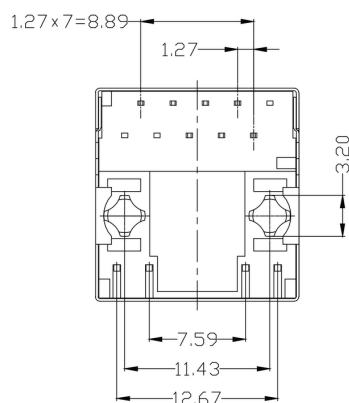
Dimensioned drawing



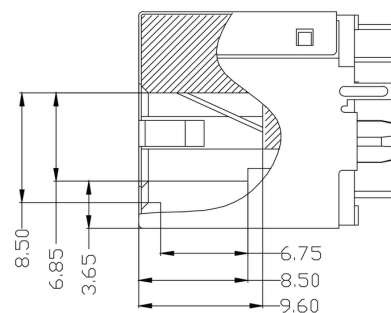
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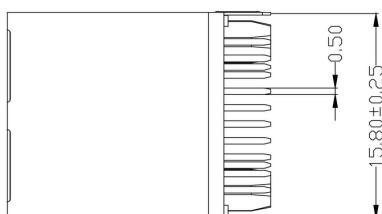
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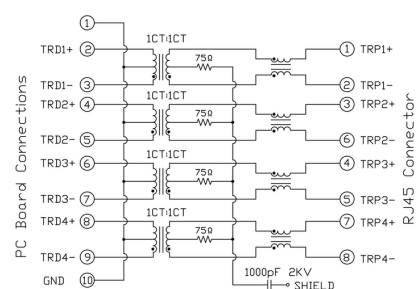
Dimensioned drawing



Dimensioned drawing



Wiring diagram

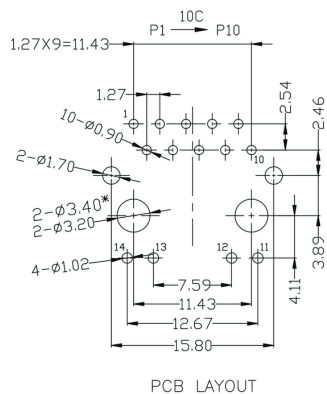


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PCB design



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Drawings

Schematic

Characteristics

Inductance	350 µH min. @ 100 kHz, 100 mV, 8 mA DC Bias
Leakage Inductance	0.3 µH max. @ 100 kHz, 100 mV
Insertion Loss	1.1 dB max. @ (1 - 100) MHz
Return Loss	18 dB min. @ (1 - 30) MHz 16 dB min. @ (30 - 60) MHz 12 dB min. @ (60 - 80) MHz
Cross Talk	30 dB min. @ (1 - 100) MHz
Common Mode Rejection	30 dB min. @ (1 - 100) MHz

Type codes

RJ45	G1	R	1	U	3.2	E	4	GY/GY	TY	RJ45G1 R1U 3.2E4GY/GY TY																																																																																																																		
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Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16

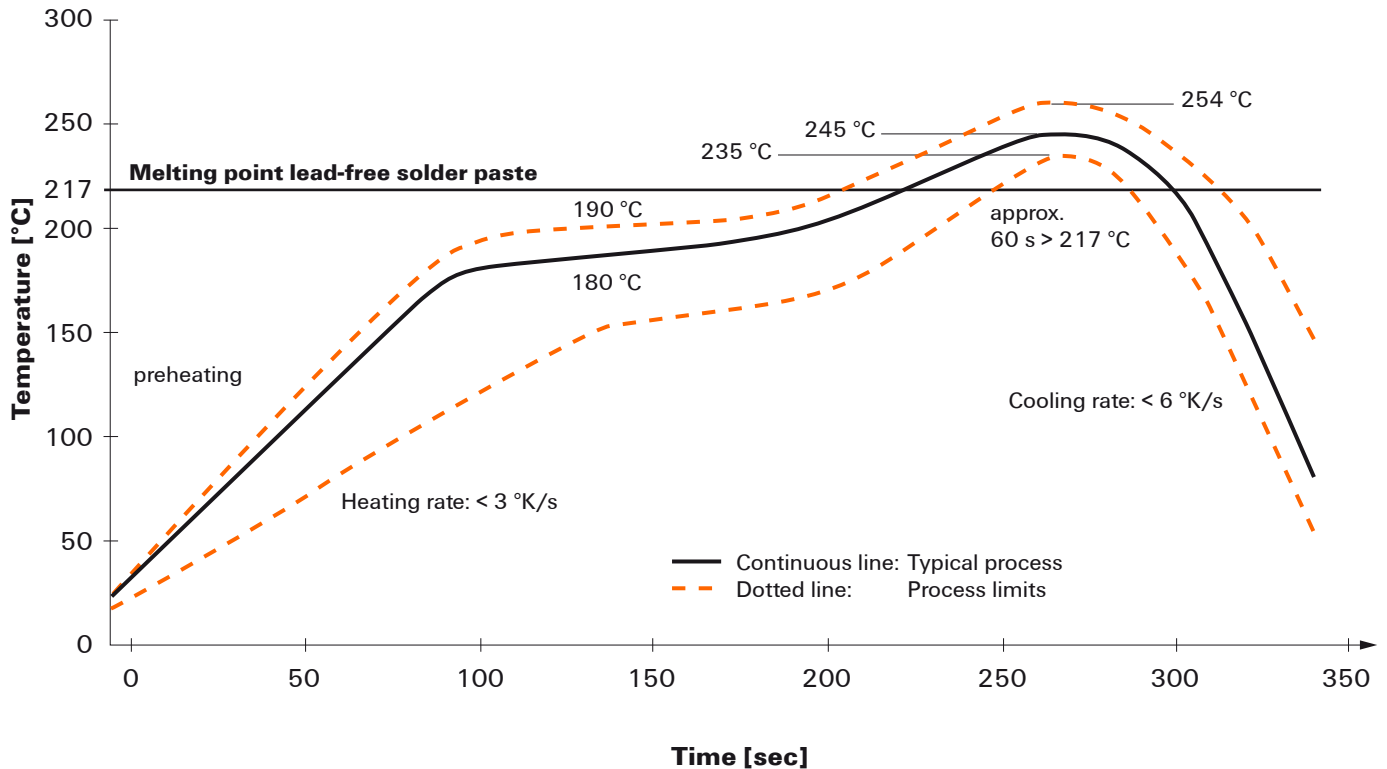
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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.